# **kHz RANGE CRYSTAL UNIT CYLINDER**

## C-TYPE C-2-TYPE/C-4-TYPE

•Frequency range : 32.768 kHz (20 kHz to 192 kHz)

•Thickness : \$\phi1.2 \text{ mm to \$\phi3.1 \text{ mm}}\$

•Overtone order : Fundamental / Overtone(192 kHz)

•Applications : Clock and Microcomputer



#### Specifications for C-TYPE (characteristics)

Item	Symbol	C-001R C-002RX C-004R C-005R		Remarks			
Nominal frequency range	f_nom	32.768 kHz					
Temperature Storage temperature	T_stg		-20 °C to +70 °C			Store as bare product after unpacking	
range Operating temperature	T_use		-10 °C to +60 °C				
Level of drive	DL		1.0 μW				
Frequency tolerance (standard)	f_tol		±20×10 <sup>-6</sup>			+25 °C, DL=0.1 μW	
Turnover temperature	Ti	+25 °C ±5 °C					
Parabolic coefficient	В	-0.04 × 10 <sup>-6</sup> / °C <sup>2</sup> Max.					
Load capacitance	CL		6 pF to ∞		Please specify		
Motional resistance (ESR)	R <sub>1</sub>	35 kΩ Max.	50 or 60 k $\Omega$ Max.	50 kΩ Max.	50 kΩ Max.		
Motional resistance (ESR)	IN1	(18 kΩ Typ.)	(30 kΩ Typ.)	(30 kΩ Typ.)	(37 kΩ Typ.)		
Motional capacitance	C <sub>1</sub>	2.1 fF Typ.	2.0 fF	2.0 fF	1.9 fF Typ.		
Shunt capacitance	C <sub>0</sub>	0.9 pF Typ.	0.85 pF	0.85 pF	0.75 pF Typ.		
Frequency aging	f_age	$\pm 3 \times 10^{-6}$ / year Max.			+25 °C, First year		

#### Specifications for C-2-TYPE C-4-TYPE (characteristics)

Item	Symbol	Specific	Remarks			
item	Syllibol	C-2-TYPE	C-4-TYPE	Kemarks		
Nominal frequency range	f_nom	20 kHz to 165 kHz 32 kHz to 120 kHz, 192 kHz				
Temperature Storage temperature	T_stg	-20 °C to	-20 °C to +70 °C			
range Operating temperature	T_use	-10 °C to +60 °C				
Level of drive	DL	1.0 μW	Max.			
Frequency tolerance (standard) f_tol		$\pm 20 \times 10^{-6}, \pm 50 \times 10^{-6}, \pm 100 \times 10^{-6}$	$\pm 50 \times 10^{-6}, \pm 100 \times 10^{-6}$	+25 °C, DL=0.1 μW		
Turnover temperature Ti		+25 °C ±5 °C				
Parabolic coefficient	В	-0.04 × 10 <sup>-6</sup> / °C <sup>2</sup> Max.				
Load capacitance	CL	6 pF to ∞		Please specify		
Motional resistance (ESR)	R <sub>1</sub>	As per below table				
Motional capacitance	C <sub>1</sub>	4.0 fF to 0.6 fF				
Shunt capacitance	C <sub>0</sub>	2.0 pF to 0.6 pF				
Frequency aging	f_age	$\pm 5 \times 10^{-6}$ / year Max.		$\pm 5 \times 10^{-6}$ / year Max.		+25 °C, First year

#### Motional resistance C-2- TYPE

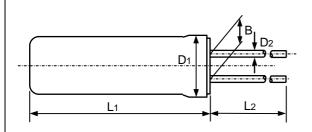
Frequency	20 kHz≤ f_nom <31.2 kHz	31.2 kHz≤ f_nom <40 kHz	40 kHz≤ f_nom <90 kHz	90 kHz≤ f_nom <130 kHz	130 kHz≤ f_nom ≤165 kHz
Motional resistance	55 kO May	35 kO Max	20 kO May	12 kO Max	10 kO May

#### Motional resistance C-4- TYPE

Frequency	32 kHz≤ f_nom <38 kHz	38 kHz≤ f_nom <60 kHz	60 kHz≤ f_nom <74 kHz	74 kHz≤ f_nom ≤100 kHz	100 kHz< f_nom ≤120 kHz	192 kHz
Motional resistance	55 kΩ Max.	30 kΩ Max.	25 kΩ Max.	22 kΩ Max.	15 kΩ Max.	10 kΩ Max.

#### External dimensions

(Unit:mm)



Model	L <sub>1</sub>	L2	D <sub>1</sub>	D <sub>2</sub>	В
C-001R	8.0 Max.	9.0 Min.	ф 3.1 Max.	φ 0.3	1.1
C-002RX C-2-TYPE	6.0 Max.	4.0 Min.	ф 2.0 Max.	φ 0.2	0.7
C-004R C-4-TYPE	5.0 Max.	4.0 Min.	ф 1.5 Max.	ф 0.18	0.5
C-005R	4.6 Max.	4.0 Min.	φ 1.2 Max.	φ 0.15	0.3

160 kHz to 165 kHz:D1= Ø 2.2 Max.(C-2-TYPE)

### "QMEMS" EPSON TOYOCOM

In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a "3D (three device) strategy" designed to drive both horizontal and vertical growth. We will to grow our three device categories of "Timing Devices", "Sensing Devices" and "Optical Devices", and expand vertical growth through a combination of products from these categories.

A Quartz MEMS is any high added value quartz device that exploits the characteristics of quartz crystal material but that is produced using MEMS (micro-electro-mechanical system) processing technology.

Market needs are advancing faster than previously imagined toward smaller, more stable crystal products, but we will stay ahead of the curve by rolling out products that exceed market speed and quality requirements. We want to further accelerate the 3D strategy by QMEMS.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers "Digital Convergence" solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.



# PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

#### **WORKING FOR HIGH QUALITY**

In order provide high quality and reliable products and services than meet customer needs,

Epson Toyocom made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

ISO/TS 16949 is a global standard based on QS-9001, a severe standard corresponding to the requirements from the automobile industry.

Explanation of the mark that are using it for the catalog



▶ Pb free.



► Complies with EU RoHS directive.

About the products without the Pb-free mark.
Contains Pb in products exempted by EU RoHS directive.
(Contains Pb in sealing glass, high melting temperature type solder or other.)



► The products have been designed for high reliability applications such as Automotive.

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- In this new crystal master for Epson Toyocom, product codes and markings will remain as previously identified prior to the merger.

  Due to the on-going strategy of gradual unification of part numbers, please review product codes and markings, as they will change during the course of the coming months.

We apologize for the inconvenience, but we will eventually have a unified part numbering system for Epson Toyocom that will be user friendly.